

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74LCX164245FT

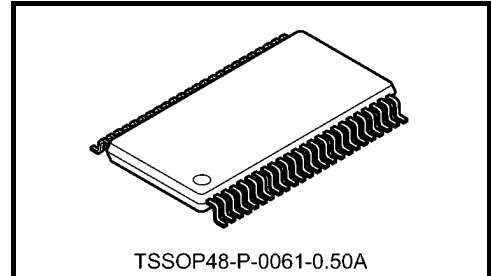
## 16-Bit Dual Supply Bus Transceiver

The TC74LCX164245FT is a dual supply, advanced high-speed CMOS 16-bit dual supply voltage interface bus transceiver fabricated with silicon gate CMOS technology.

Designed for use as an interface between a 5-V bus and a 3.3-V or 2.5-V bus in mixed 5-V/3.3-V or 2.5-V supply systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

It is intended for 2 way asynchronous communication between data busses. The direction of data transmission is determined by the level of the DIR input. The enable input ( $\overline{OE}$ ) can be used to disable the device so that the busses are effectively isolated. The B-port interfaces with the 5-V bus, the A-port with the 3.3-V or 2.5-V bus.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.



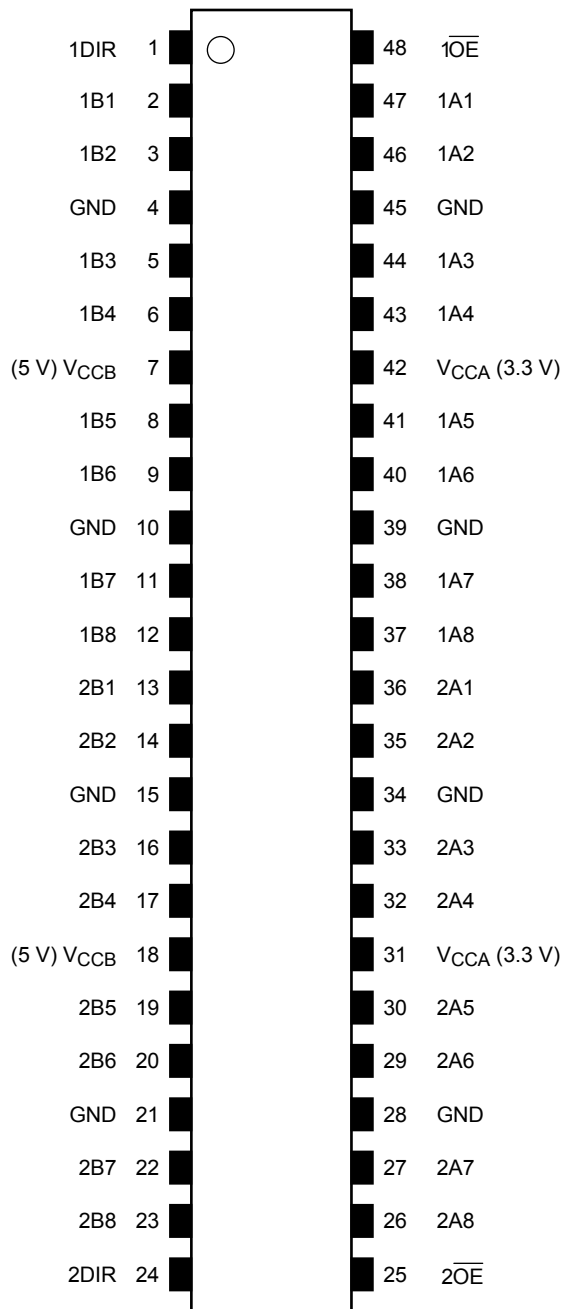
Weight: 0.25 g (typ.)

### Features (Note)

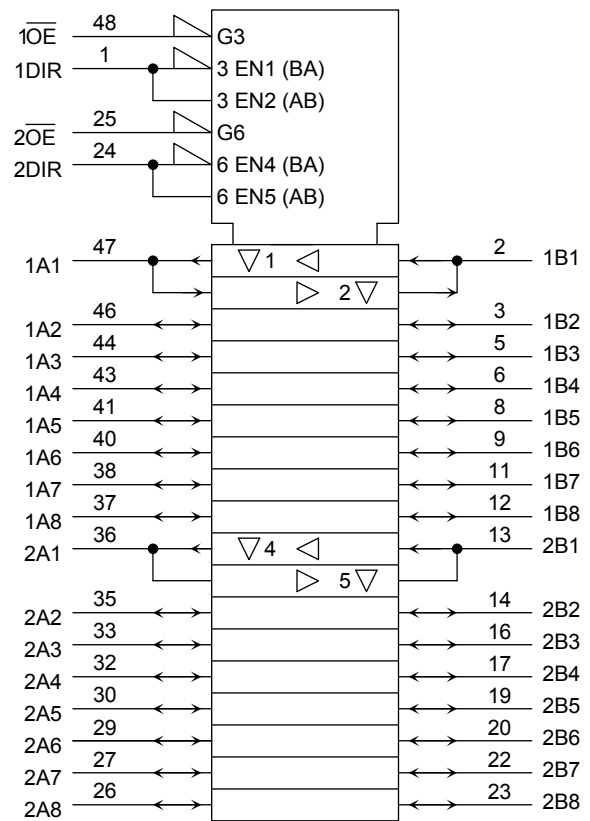
- Bidirectional interface between 5-V and 3.3-V or 2.5-V buses
- High-speed:  $t_{pd} = 5.8$  ns (max)  
( $V_{CCB} = 5.0 \pm 0.5$  V/ $V_{CCA} = 3.3 \pm 0.3$  V,  $T_a = -40$  to  $85^\circ\text{C}$ )
- Low power dissipation:  $I_{CC} = 80$   $\mu\text{A}$  (max) ( $T_a = -40$  to  $85^\circ\text{C}$ )
- Symmetrical output impedance:  $I_{OUTA} = \pm 24$  mA (min)  
 $I_{OUTB} = \pm 24$  mA (min)  
( $V_{CCA} = 3.0$  V/ $V_{CCB} = 4.5$  V)
- Power-down protection provided on all inputs and outputs
- Allows A port and  $V_{CCA}$  to float simultaneously when  $\overline{OE}$  is "H".
- Latch-up performance:  $-500$  mA
- Package: TSSOP

Note: Do not apply a signal to any bus pins when it is in the output mode. Damage may result.  
All floating (high impedance) bus pins must have their input fixed by means of pull-up or pull-down resistors.

## Pin Assignment (top view)



## IEC Logic Symbol



## Truth Table

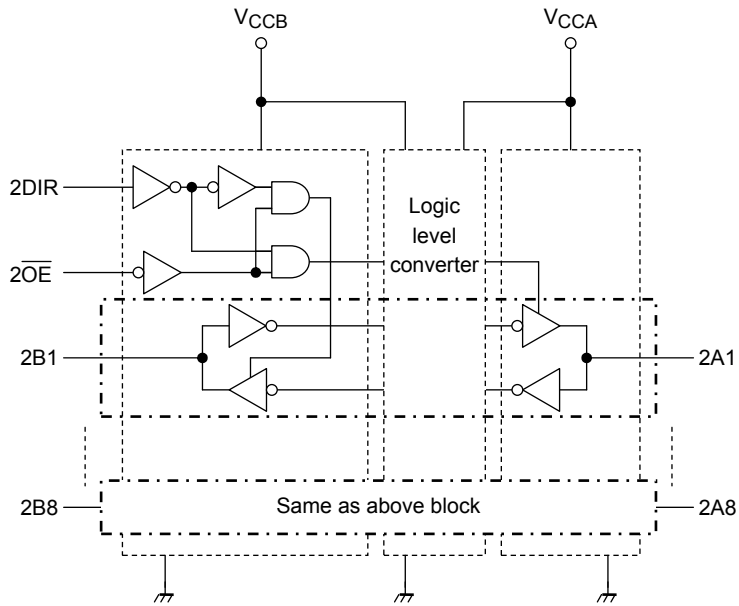
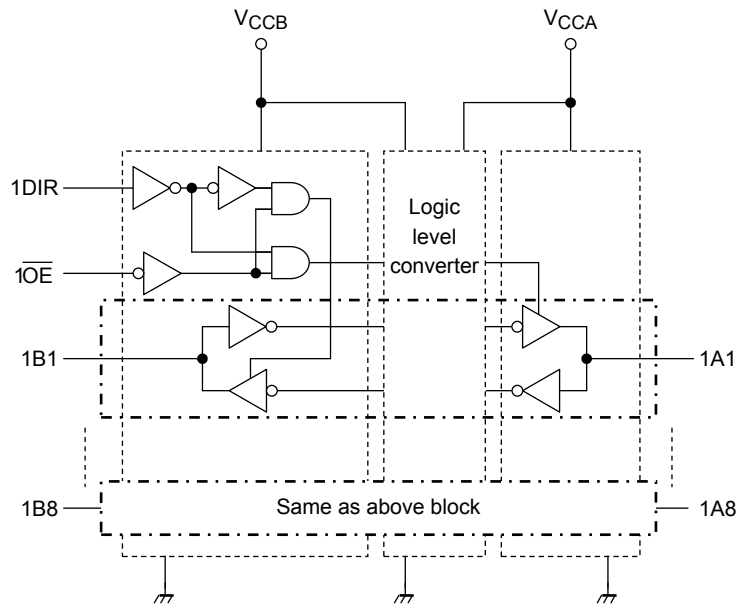
Inputs		Function		Outputs
$\overline{1OE}$	1DIR	Bus 1A1-1A8	Bus 1B1-1B8	
L	L	Output	Input	A = B
L	H	Input	Output	B = A
H	X	Z		Z

Inputs		Function		Outputs
$\overline{2OE}$	2DIR	Bus 2A1-2A8	Bus 2B1-2B8	
L	L	Output	Input	A = B
L	H	Input	Output	B = A
H	X	Z		Z

X: Don't care

Z: High impedance

**Block Diagram**



## Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Power supply voltage (Note 2)	$V_{CCB}$	-0.5 to 7.0	V
	$V_{CCA}$	-0.5 to $V_{CCB} + 0.5$	
DC input voltage (DIR, $\overline{OE}$ )	$V_{IN}$	-0.5 to 7.0	V
DC bus I/O voltage	$V_{I/OB}$	-0.5 to 7.0 (Note 3)	V
		-0.5 to $V_{CCB} + 0.5$ (Note 4)	
	$V_{I/OA}$	-0.5 to 7.0 (Note 3)	
		-0.5 to $V_{CCA} + 0.5$ (Note 4)	
Input diode current	$I_{IK}$	-50	mA
Output diode current	$I_{I/OK}$	$\pm 50$ (Note 5)	mA
DC output current	$I_{OUTB}$	$\pm 50$	mA
	$I_{OUTA}$	$\pm 50$	
DC $V_{CC}$ /ground current per supply pin	$I_{CCB}$	$\pm 100$	mA
	$I_{CCA}$	$\pm 100$	
Power dissipation	$P_D$	400	mW
Storage temperature	$T_{stg}$	-65 to 150	$^{\circ}\text{C}$

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: Don't supply a voltage to  $V_{CCA}$  terminal when  $V_{CCB}$  is in the off-state.

Note 3: OFF state

Note 4: High or low state.  $I_{OUT}$  absolute maximum rating must be observed.

Note 5:  $V_{OUT} < \text{GND}$ ,  $V_{OUT} > V_{CC}$

## Operating Ranges (Note 1)

Characteristics	Symbol	Rating	Unit
Power supply voltage	$V_{CCB}$	4.5 to 5.5	V
	$V_{CCA}$	2.3 to 3.6	
Input voltage (DIR, $\overline{OE}$ )	$V_{IN}$	0 to 5.5	V
Bus I/O voltage	$V_{I/OB}$	0 to 5.5 (Note 2)	V
		0 to $V_{CCB}$ (Note 3)	
	$V_{I/OA}$	0 to 5.5 (Note 2)	
		0 to $V_{CCA}$ (Note 3)	
Output current	$I_{OUTB}$	$\pm 24$ (Note 4)	mA
		$\pm 24$ (Note 5)	
	$I_{OUTA}$	$\pm 8$ (Note 6)	
Operating temperature	$T_{opr}$	-40 to 85	$^{\circ}\text{C}$
Input rise and fall time	$dt/dv$	0 to 10 (Note 7)	ns/V

Note 1: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND. Please connect both bus inputs and the bus outputs with VCC or GND when the I/O of the bus terminal changes by the function. In this case, please note that the output is not short-circuited.

Note 2: OFF state

Note 3: High or low state

Note 4:  $V_{CCB} = 4.5$  to  $5.5$  V

Note 5:  $V_{CCA} = 3.0$  to  $3.6$  V

Note 6:  $V_{CCA} = 2.3$  to  $2.7$  V

Note 7:  $V_{INB} = 0.8$  to  $2.0$  V,  $V_{CCB} = 5.0$  V  
 $V_{INA} = 0.8$  to  $2.0$  V,  $V_{CCA} = 3.0$  V

## Electrical Characteristics

### DC Characteristics

Characteristics	Symbol	Test Condition	V <sub>CCB</sub> (V)	V <sub>CCA</sub> (V)	Ta = -40 to 85°C		Unit		
					Min	Max			
H-level input voltage	V <sub>IHB</sub>	DIR, $\overline{OE}$ , Bn	5.0 ± 0.5	2.3 to 3.6	2.0	—	V		
	V <sub>IHA</sub>	An	5.0 ± 0.5	2.5 ± 0.2	1.7	—			
			5.0 ± 0.5	3.3 ± 0.3	2.0	—			
L-level input voltage	V <sub>ILB</sub>	DIR, $\overline{OE}$ , Bn	5.0 ± 0.5	2.3 to 3.6	—	0.8	V		
	V <sub>I LA</sub>	An	5.0 ± 0.5	2.5 ± 0.2	—	0.7			
			5.0 ± 0.5	3.3 ± 0.3	—	0.8			
H-level output voltage	V <sub>OHB</sub>	V <sub>I NA</sub> = V <sub>I HA</sub> or V <sub>I LA</sub>	I <sub>OHB</sub> = -100 μA I <sub>OHB</sub> = -24 mA	5.0 ± 0.5	2.3 to 3.6	V <sub>CCB</sub> - 0.2	—	V	
				4.5	2.3 to 3.6	3.8	—		
	V <sub>OHA</sub>		V <sub>I NB</sub> = V <sub>I HB</sub> or V <sub>I LB</sub>	I <sub>OHA</sub> = -100 μA I <sub>OHA</sub> = -24 mA	5.0 ± 0.5	2.3 to 3.6	V <sub>CCA</sub> - 0.2		—
					5.0 ± 0.5	3.0	2.2		—
				I <sub>OHA</sub> = -8 mA	5.0 ± 0.5	2.3	1.8		—
					5.0 ± 0.5	2.3	1.8		—
L-level output voltage	V <sub>OLB</sub>	V <sub>I NA</sub> = V <sub>I HA</sub> or V <sub>I LA</sub>	I <sub>OLB</sub> = 100 μA I <sub>OLB</sub> = 24 mA	5.0 ± 0.5	2.3 to 3.6	—	0.2	V	
				4.5	2.3 to 3.6	—	0.44		
	V <sub>OLA</sub>		V <sub>I NB</sub> = V <sub>I HB</sub> or V <sub>I LB</sub>	I <sub>OLA</sub> = 100 μA I <sub>OLA</sub> = 24 mA	5.0 ± 0.5	2.3 to 3.6	—		0.2
					5.0 ± 0.5	3.0	—		0.55
				I <sub>OLA</sub> = 8 mA	5.0 ± 0.5	2.3	—		0.6
					5.0 ± 0.5	2.3	—		0.6
3-state output OFF state current	I <sub>OZB</sub>	V <sub>I N</sub> = V <sub>I HB</sub> or V <sub>I LB</sub> V <sub>I/OB</sub> = 0 to 5.5 V	5.0 ± 0.5	2.3 to 3.6	—	±5.0	μA		
	I <sub>OZA</sub>	V <sub>I N</sub> = V <sub>I HB</sub> or V <sub>I LB</sub> V <sub>I/OA</sub> = 0 to 5.5 V	5.0 ± 0.5	2.3 to 3.6	—	±5.0			
Input leakage current	I <sub>IN</sub>	V <sub>I N</sub> (DIR, $\overline{OE}$ ) = 0 to 5.5 V	5.5	3.6	—	±5.0	μA		
Power-off leakage current	I <sub>OFF</sub>	V <sub>I NA</sub> /V <sub>I NB</sub> = 5.5 V	0	0	—	10	μA		
Quiescent supply current	I <sub>CCB1</sub>	V <sub>I/OA</sub> = Open, V <sub>CCA</sub> = Open V <sub>I NB</sub> = V <sub>CCB</sub> or GND $\overline{OE}$ = V <sub>CCB</sub> , DIR = GND	5.5	Open	—	80	μA		
	I <sub>CCB2</sub>	V <sub>I NA</sub> = V <sub>CCA</sub> or GND V <sub>I NB</sub> = V <sub>CCB</sub> or GND	5.5	3.6	—	80			
	I <sub>CCA</sub>	V <sub>I NA</sub> = V <sub>CCA</sub> or GND V <sub>I NB</sub> = V <sub>CCB</sub> or GND	5.5	3.6	—	50			
	I <sub>CCTB</sub>	V <sub>I NB</sub> = 3.4 V per input	5.5	2.3 to 3.6	—	2.0		mA	
	I <sub>CCTA</sub>	V <sub>I NA</sub> = V <sub>CCA</sub> - 0.6 V per input	5.0 ± 0.5	3.6	—	500		μA	

## AC Characteristics (input: $t_r = t_f = 2.5 \text{ ns}$ , $R_L = 500 \Omega$ )

$V_{CCA} = 3.3 \pm 0.3 \text{ V}$

Characteristics	Symbol	Test Condition	CL (pF)	$V_{CCB}$ (V)	Ta = -40 to 85°C		Unit
					Min	Max	
Propagation delay time (Bn → An)	$t_{pLH}$ $t_{pHL}$	Input: Bn Output: An (DIR = "L")	50	$5.0 \pm 0.5$	1.0	5.8	ns
3-state output enable time ( $\overline{OE}$ → An)	$t_{pZL}$ $t_{pZH}$		50	$5.0 \pm 0.5$	1.0	9.0	
3-state output disable time ( $\overline{OE}$ → An)	$t_{pLZ}$ $t_{pHZ}$		50	$5.0 \pm 0.5$	1.0	9.0	
Propagation delay time (An → Bn)	$t_{pLH}$ $t_{pHL}$	Input: An Output: Bn (DIR = "H")	50	$5.0 \pm 0.5$	1.0	5.8	ns
3-state output enable time ( $\overline{OE}$ → Bn)	$t_{pZL}$ $t_{pZH}$		50	$5.0 \pm 0.5$	1.0	8.9	
3-state output disable time ( $\overline{OE}$ → Bn)	$t_{pLZ}$ $t_{pHZ}$		50	$5.0 \pm 0.5$	1.0	9.0	
Output to output skew	$t_{osLH}$ $t_{osHL}$	(Note)	50	$5.0 \pm 0.5$	—	1.0	ns

Note: Parameter guaranteed by design.  
 $(t_{osLH} = |t_{pLHm} - t_{pLHn}|, t_{osHL} = |t_{pHLm} - t_{pHLn}|)$

$V_{CCA} = 2.5 \pm 0.2 \text{ V}$

Characteristics	Symbol	Test Condition	CL (pF)	$V_{CCB}$ (V)	Ta = -40 to 85°C		Unit
					Min	Max	
Propagation delay time (Bn → An)	$t_{pLH}$ $t_{pHL}$	Input: Bn Output: An (DIR = "L")	30	$5.0 \pm 0.5$	1.0	8.4	ns
3-state output enable time ( $\overline{OE}$ → An)	$t_{pZL}$ $t_{pZH}$		30	$5.0 \pm 0.5$	1.0	11.0	
3-state output disable time ( $\overline{OE}$ → An)	$t_{pLZ}$ $t_{pHZ}$		30	$5.0 \pm 0.5$	1.0	10.0	
Propagation delay time (An → Bn)	$t_{pLH}$ $t_{pHL}$	Input: An Output: Bn (DIR = "H")	50	$5.0 \pm 0.5$	1.0	9.0	ns
3-state output enable time ( $\overline{OE}$ → Bn)	$t_{pZL}$ $t_{pZH}$		50	$5.0 \pm 0.5$	1.0	10.5	
3-state output disable time ( $\overline{OE}$ → Bn)	$t_{pLZ}$ $t_{pHZ}$		50	$5.0 \pm 0.5$	1.0	10.3	
Output to output skew	$t_{osLH}$ $t_{osHL}$	(Note)	30 or 50	$5.0 \pm 0.5$	—	1.0	ns

Note: Parameter guaranteed by design.  
 $(t_{osLH} = |t_{pLHm} - t_{pLHn}|, t_{osHL} = |t_{pHLm} - t_{pHLn}|)$

## Capacitive Characteristics (Ta = 25°C)

V<sub>CCB</sub> = 5.0 V

Characteristics	Symbol	Test Circuit	Test Condition	V <sub>CCA</sub> (V)	Typ.	Unit
Input capacitance	C <sub>IN</sub>	—	DIR, $\overline{OE}$	2.5, 3.3	7	pF
Output capacitance	C <sub>I/O</sub>	—	An, Bn	2.5, 3.3	8	pF
Power dissipation capacitance (Note)	C <sub>PDA</sub>	—	A ⇒ B (DIR = "H")	2.5, 3.3	2	pF
			B ⇒ A (DIR = "L")	2.5, 3.3	26	
	C <sub>PDB</sub>	—	A ⇒ B (DIR = "H")	2.5, 3.3	36	
			B ⇒ A (DIR = "L")	2.5, 3.3	4	

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

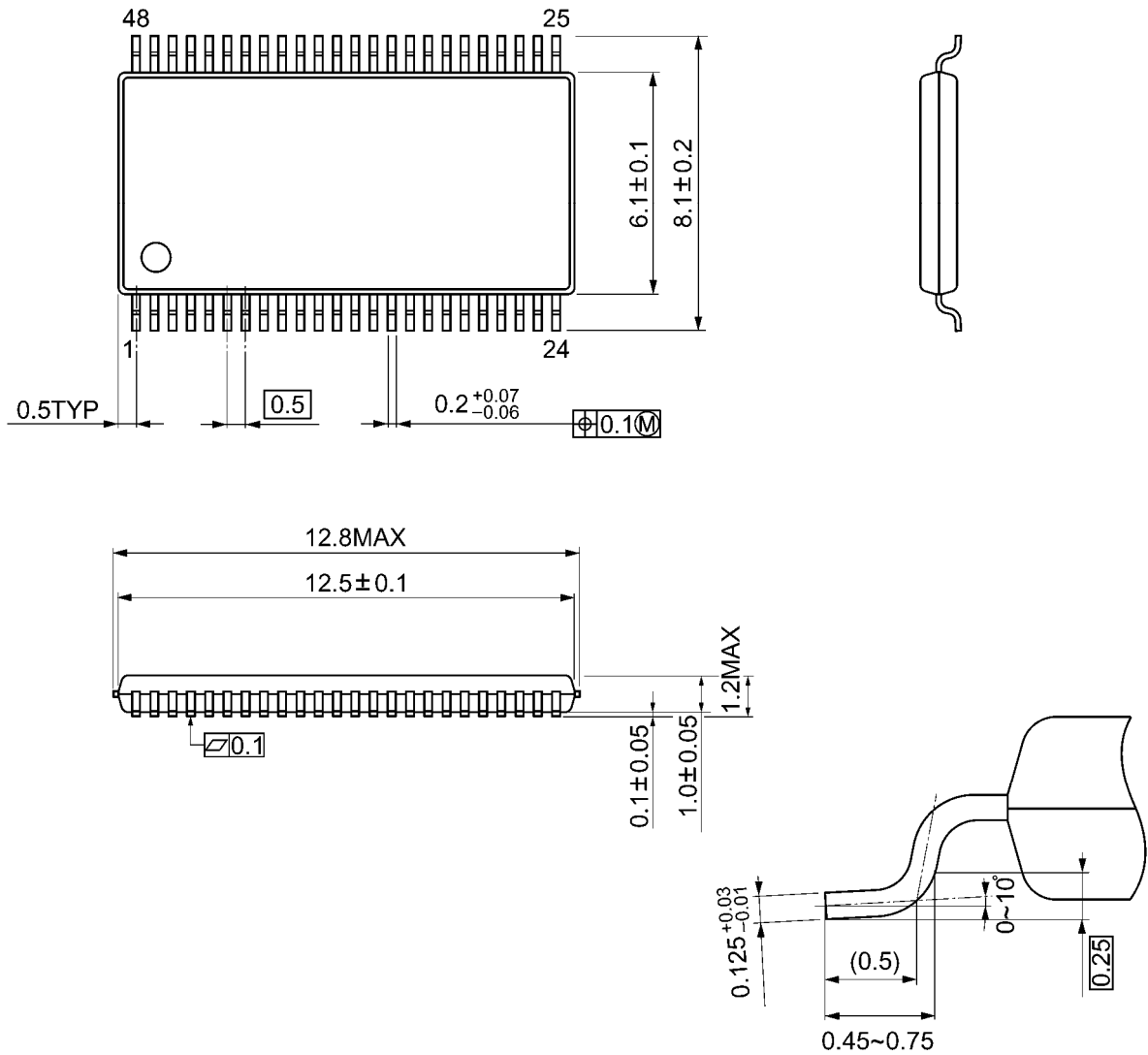
Average operating current can be obtained by the equation:

$$I_{CC(opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/16 \text{ (per bit)}$$

**Package Dimensions**

TSSOP48-P-0061-0.50A

Unit: mm



Weight: 0.25 g (typ.)

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